

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM337554

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST		
SEQUENCE:	1		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
Patriot Capital II, L.P.		03/31/2015	LIMITED PARTNERSHIP: DELAWARE
RECEIVING PARTY DATA			
Name:	R&D Circuits Holdings LLC		
Street Address:	3601 South Clinton Avenue		
City:	South Plainfield		
State/Country:	NEW JERSEY		
Postal Code:	07080		
Entity Type:	LIMITED LIABILITY COMPANY: DELAWARE		
Name:	R & D Circuits		
Street Address:	3601 South Clinton Avenue		
City:	South Plainfield		
State/Country:	NEW JERSEY		
Postal Code:	07080		
Entity Type:	CORPORATION: NEW JERSEY		
Name:	R&D Sockets, Inc.		
Street Address:	1660 E. Race Street		
City:	Allentown		
State/Country:	PENNSYLVANIA		
Postal Code:	18109		
Entity Type:	CORPORATION: DELAWARE		
Name:	R&D Altanova, Inc.		
Street Address:	6810 Santa Teresa Blvd.		
City:	San Jose		
State/Country:	CALIFORNIA		
Postal Code:	95119		
Entity Type:	CORPORATION: CALIFORNIA		
Name:	R&D Altanova Taiwan LLC		
Street Address:	No. 1, Jinshan 7th Street		

OP \$265.00 3827708

Internal Address:	East Dist.
City:	Hsinchu City
State/Country:	TAIWAN
Postal Code:	300
Entity Type:	LIMITED LIABILITY COMPANY: CALIFORNIA

PROPERTY NUMBERS Total: 10

Property Type	Number	Word Mark
Registration Number:	3827708	QUALITY ACROSS THE BOARD
Registration Number:	3944000	KGLB
Registration Number:	3906040	KNOWN GOOD BOARD
Registration Number:	3909579	KNOWN GOOD LOAD BOARD
Registration Number:	4040884	ELASTECH
Serial Number:	85176668	ELASTCONNECT
Serial Number:	85200613	VIA ANYWHERE
Serial Number:	85179965	CONNECTFLEX
Serial Number:	85105352	EC TECHNOLOGY
Serial Number:	85106196	TECHNOLOGY SOLUTIONS ACROSS THE BOARD

CORRESPONDENCE DATA

Fax Number: 6172484000

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: tadmin@choate.com

Correspondent Name: Elizabeth A. Walker

Address Line 1: Two International Place

Address Line 2: Choate Hall & Stewart LLP

Address Line 4: Boston, MASSACHUSETTS 02110

ATTORNEY DOCKET NUMBER:	0631999.0087
NAME OF SUBMITTER:	Elizabeth A. Walker
SIGNATURE:	/Elizabeth A. Walker/
DATE SIGNED:	04/07/2015

Total Attachments: 11

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TERMINATION AND RELEASE OF INTELLECTUAL PROPERTY SECURITY AGREEMENT

TERMINATION AND RELEASE OF INTELLECTUAL PROPERTY SECURITY AGREEMENT, dated as of March 31, 2015, is executed by **PATRIOT CAPITAL II, L.P.** ("Lender"), in favor of **R&D CIRCUITS HOLDINGS LLC**, a Delaware limited liability company, **R & D CIRCUITS**, a New Jersey corporation, **R&D SOCKETS, INC.**, a Delaware corporation, **R&D ALTANOVA, INC.**, a California corporation (formerly known as Altanova Corporation), and **R&D ALTANOVA TAIWAN LLC**, a California limited liability company (formerly known as Servitest, LLC) (collectively, "Borrower").

WHEREAS, Borrower previously granted to Lender a security interest (the "Security Interest") upon, and assigned to Lender all of Borrower's right, title and interest in, certain of Borrower's patents, copyrights, licenses, trademarks and applications for the foregoing, more particularly described on **Exhibits A, B, C and D** attached hereto (the "Collateral"), which Security Interest was recorded with the United States Patent and Trademark Office at Reel 004631, Frame 0912, on September 28, 2011 and at Reel 026982, Frame 0222, on September 28, 2011 (collectively, the "Security Agreement"), for the purpose of securing payment and performance of certain obligations of Borrower to Lender (the "Obligations");

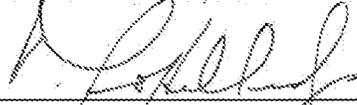
WHEREAS, on or prior to the date hereof, Borrower has paid and performed in full the Obligations and, as such, Lender has agreed to terminate the Security Agreement and to release, and terminate its Security Interest in, the Collateral and assign and transfer to Borrower all deeds, assignments and other instruments as may be necessary or proper to reassign and reconvey to re-vest in Borrower the entire right, title and interest to the Collateral as herein provided;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, and intending to be legally bound hereby, Lender hereby releases and terminates the Security Interest and assigns and transfers to Borrower, without representation, warranty or recourse, all of Lender's right, title and interest in and to the Collateral, effective as of the date set forth above.

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IN WITNESS WHEREOF, Lender has executed and delivered this Termination and Release of Intellectual Property Security Agreement.

PATRIOT CAPITAL II, L.P.

By: 

Name: THOMAS O. HOKLAND, JR.

Title: MANAGING MEMBER

[Termination And Release of Intellectual Property Security Agreement (Patriot)]

TRADEMARK
REEL: 005494 FRAME: 0067

STATE OF _____

_____ :
: SS.

COUNTY OF _____

On this 2nd day of March, 2015, before me, a Notary Public, personally appeared THOMAS O. HOLLAND, SA, who acknowledged himself/herself to be the Managing Director of PATRIOT CAPITAL II, L.P., and being authorized to do so, executed the within instrument as such officer, for the purposes herein contained.

IN WITNESS HEREOF, I hereunto set my hand and official seal.


Notary Public

My Commission Expires: 4/11/18

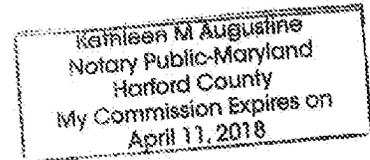


EXHIBIT A

Title	Application/Patent Number (Filed/Issued)
Apparatus and Method for a Conductive Elastomer on a Coaxial Cable or a Microcable to Improve Signal Integrity Probing	61/459,239 (INSERT FILING DATE)
Electrical Connector for Connecting an Adaptor Board or Electrical Component to a Main Printed Circuit Board	61/340,277 (3/15/2010)
Electrical Connector for Connecting an Adaptor Board or Electrical Component to a Main Printed Circuit Board	61/340,519 (3/18/2010)
Electrical Connector for Connecting an Adaptor Board or Electrical Component to a Main Printed Circuit Board	13/065,006 (3/11/2011)
Embedded Circuits in Interposer Board for Improving Power Distribution and Power Dissipation in Interconnect Configuration	61/276,661 (9/15/2009)
An Apparatus For Improved Power Distribution Or Power Dissipation To An Electrical Component And Method For The Same	8,743,554 (June 3, 2014)
Laser Skived Solder Dam	61/284,979 (12/30/2009)
Method and Apparatus for Scoring or Skiving a Solder Dam	12/798,216 (3/31/2010)

Method and Apparatus for Improving Power Distribution and Dissipation for Interconnect Configurations	61/215,369 (5/4/2009)
Method and Apparatus for Improving Power Gain and Loss for Interconnect Configurations	12/655,858 (1/8/2010)
Method and Structure for Coaxial Via Routing in Printed Circuit Boards for Improved Signal Integrity	61/338,918 (2/25/2010)
Method and Structure for Coaxial via Routing in Printed Circuit Boards for Improved Signal Integrity	8,354,601 (1/15/2013)
Method And Structure For Directly Connecting Coaxial Or Micro Coaxial Cables To The Interior Side Of Pads Of A Printed Circuit Board To Improve Signal Integrity Of An Electrical Circuit	61/397,170 (6/8/2010)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	61/008,262 (12/18/2007)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	61/009,272 (12/27/2007)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	7,766,667 (8/3/2010)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	7,931,476 (4/26/2011)

Method for Reducing Contact Resistance in Interconnect Medium	61/456,299 (11/4/2010)
Embedded Isolation Filter	61/404,521 (10/5/2010)
Looped Wire Elastomeric Contactor	61/401,027 (8/6/2010)
Circuit Board Stiffener	7,381,908
Title	Application/Patent Number (Filed/Issued)
Embedded Components in Interposer Board for Improving Power Gain (Distribution) and power loss (Dissipation) in interconnect configuration	PCT/US2010/00049 (1/8/2010)
Embedded Components in Interposer Board for Improving Power Gain (Distribution) and power loss (Dissipation) in interconnect configuration	Taiwan 99128788 (4/1/2011)
Method and Apparatus for Improving Power Gain and Loss for Interconnect Configurations	PCT/US/2010/00043 (1/8/2010)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	PCT/US2008/013842 (12/17/2008)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	Korea 10-1262463 (6/25/2013)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	Japan JP5563477 (7/30/2014)

Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	Singapore 162150 (12/31/2012)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	Taiwan I462412 (11/21/2014)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	China 200880121549.9 (12/17/2008)
Separable Electrical Connectors Using Isotropic Conductive Elastomer Interconnect Medium	Europe 08863567.7 (12/17/2008)

EXHIBIT B

COPYRIGHTS
NONE

EXHIBIT C

1. Purchase Agreement, by and between Intel Corporation and the Company dated February 8, 2011.
2. Purchasing Order, by and between Ansys, Inc. and the Company, dated September 30, 2010.
3. Maintenance Service Agreement, by and between Orbotech, Inc. and the Company, dated December 16, 2010, together with Purchase Order dated December 17, 2010.
4. Maintenance Service Agreement, by and between Orbotech, Inc. and the Company, dated December 20, 2010, together with Purchase Order dated January 25, 2011.
5. Software License and Maintenance Agreement, by and between Cadence Design Systems, Inc. and the Company, dated November 7, 2008, together with Software Support Quotation, dated March 9, 2011.
6. Non-Exclusive License Agreement, dated September 24, 2010, between Paricon Technologies Corporation and the Company.
7. Purchasing Order, by and between Aegis Software and the Company, dated March 30, 2011.
8. Licensing Agreement, by and between Anestel and the Company, dated May 2009.
9. Software License Agreement, dated December 18, 2003, between Cimnet Systems, Inc. and the Company.

EXHIBIT D

Mark	Application/Registration Number (Filed/Registered)
ELASTCONNECT	85/176,668 (11/15/2010)
ELASTECH	4,040,884 (10/18/2011) 85/176,703 (11/15/2010)
VIA ANYWHERE	85/200,613 (12/17/2010)
CONNECTFLEX	85/179,965 (11/18/2010)
EC TECHNOLOGY	85/105,352 (8/11/2010)
KGLB	3,944,000 (4/12/2011) 85/105,102 (08/11/2010)
MOTHER-DAUGHTER TECHNOLOGY	76/675,316 (4/10/2007)
KNOWN GOOD BOARD	3,906,040 (1/11/2011) 85/105,284 (8/11/2010)
KNOWN GOOD LOAD BOARD	3,909,579 (01/18/2011) 85/104,872 (8/11/2010)
SPACE TRANSFORMER TECHNOLOGY	76/675,315 (4/10/2007)

TECHNOLOGY SOLUTIONS ACROSS THE BOARD	85/106,196 (8/12/2010)
QUALITY ACROSS THE BOARD	3,827,708 (8/3/2010)
	77/899,161 (12/22/2009)